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Applicant : BOARDCON EMBEDDED DESIGN LIMITED

Address : 2508-2509 Haofang Tianji Plaza, 11008 Beihuan Avenue, Nanshan District,

Shenzhen, Guang Dong

Sample Name : CM3588 Computer on Module

Style/Item No. CM3588

Received Date : Mar. 04, 2024

Test Period Mar. 04, 2024 ~ Mar. 22, 2024

Test Requested As requested by the client, to evaluate the compliance of the submitted sample with

> EU RoHS Directive 2011/65/EU Annex II and its amendment (EU) 2015/863 on the restriction of the use of certain hazardous substances in electrical and electronic

equipment.

1. Review was performed for the sample and the related Bill of Materials submitted **Test Method**

by the Applicant.

2. a) Refer to the standard IEC 62321-3-1:2013: Screening by XRF Spectroscopy.

b) Wet chemical test

1) Refer to IEC 62321-5:2013, determine the Cadmium, Lead content by ICP-OES.

2) Refer to IEC 62321-4:2013+A1:2017, determine the Mercury content by ICP-OES:

3) Refer to IEC 62321-7-1:2015 & IEC 62321-7-2:2017, determine the Hexavalent Chromium content by UV-VIS.

4) Refer to IEC 62321-6:2015, determine the Polybrominated Biphenyls and Polybrominated Diphenyl Ethers by GC-MS.

Refer to IEC 62321-8:2017, determine the Dibutyl phthalate(DBP), Benzylbutyl phthalate(BBP), Di-2-ethylhexyl phthalate(DEHP) and Diisobutyl phthalate(DIBP) by GC-MS.

Test Results : Please refer to next page (s).





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Conclusion:

Basing on the test results obtained from the homogenous materials, the submitted sample COMPLIES with the EU RoHS Directive 2011/65/EU Annex II and its amendment (EU) 2015/863.



Signed for and on behalf of EMTEK(Dongguan) Co., Ltd

Prepared by:

Report Engineer

Reviewed by:

Zeng Xingji, Cindy

Supervisor

Approved by:

Li Wei, Lisa Authorized signatory Mar. 22, 2024





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Test Results:

1. Pb, Cd, Hg, Cr6+, PBBs, PBDEs Test Results:

No.	Sample description	Restricted substances	Analytical element	Results of EDXRF ⁽¹⁾	Results of Chemical Testing ⁽²⁾ (mg/kg)	Conclusion	Remark	
		Pb	Pb	BL				
		Cd	Cd	BL	NA		No comment	
1	Brown PCB	Hg	Hg	BL	IVA	Pass		
'	BIOWIT F CB	Cr ⁶⁺	Cr	BL		rass	No comment	
		PBBs	Br	Х	ND			
		PBDEs	5	Λ	ND			
		Pb	Pb	BL				
		Cd	Cd	BL				
2	SMD IC	Hg	Hg	BL	NA	Pass	No comment	
	SIVID IC	Cr ⁶⁺	Cr	BL	INA INA	Pass	No comment	
		PBBs	Br	BL				
		PBDEs	ום	DL				
		Pb	Pb	BL				
		Cd	Cd	BL				
3	SMD IC	Hg	Hg	BL	NA	Pass	No comment	
3		Cr ⁶⁺	Cr	BL	INA	1 400	No comment	
		PBBs	Br	BL				
		PBDEs	5	DL				
		Pb	Pb	BL				
		Cd	Cd	BL				
4	Dark grey solid	Hg	Hg	BL	NA	Pass	No comment	
	Dark gicy 30lid	Cr ⁶⁺	Cr	BL	TNA	1 433	140 Comment	
		PBBs	Br	BL				
		PBDEs	ום	DL				
		Pb	Pb	BL				
		Cd	Cd	BL				
5	Silver metal	Hg	Hg	BL	NA	Pass	No comment	
	Silver Illetal	Cr ⁶⁺	Cr	BL	INA		140 COMMINERAL	
		PBBs	Br	NA				
		PBDEs	וט	13/7				





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No.	Sample description	Restricted substances	Analytical element	Results of EDXRF ⁽¹⁾	Results of Chemical Testing ⁽²⁾ (mg/kg)	Conclusion	Remark	
		Pb	Pb	BL				
		Cd	Cd	BL			No comment	
6	Silver metal	Hg	Hg	BL	NA	Pass		
0	Silver metal	Cr ⁶⁺	Cr	BL	IVA	F 455	No comment	
		PBBs	Br	NA				
		PBDEs	ы	INA				
		Pb	Pb	BL				
	7 SMD IC	Cd	Cd	BL		Pass	No comment	
7		Hg	Hg	BL	NIA			
/		Cr ⁶⁺	Cr	BL	NA			
		PBBs PBDEs	Br	BL				
		Pb	Pb	BL				
		Cd	Cd	BL				
0	SMD IC	Hg	Hg	BL	NIA	Pass	No comment	
8	SIMD IC	Cr ⁶⁺	Cr	BL	NA	rass	No comment	
		PBBs PBDEs	Br	BL				
		Pb	Pb	BL				
		Cd	Cd	BL				
		Hg	Hg	BL				
9	SMD capacitor	Cr ⁶⁺	Cr	BL	NA	Pass	No comment	
		PBBs						
		PBDEs	Br	BL				
		Pb	Pb	BL				
		Cd	Cd	BL				
		Hg	Hg	BL		Pass		
10	Black solid	Cr ⁶⁺	Cr	BL	NA		No comment	
		PBBs						
		PBDEs	Br	BL				





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No.	Sample description	Restricted substances	Analytical element	Results of EDXRF ⁽¹⁾	Results of Chemical Testing ⁽²⁾ (mg/kg)	Conclusion	Remark	
		Pb	Pb	BL				
		Cd	Cd	BL				
11	SMD IC	Hg	Hg	BL	NA	D	No comment	
11	SIMD IC	Cr ⁶⁺	Cr	BL	INA	Pass	No comment	
		PBBs	Br	BL				
		PBDEs	ы	DL				
		Pb	Pb	BL				
		Cd	Cd	BL				
40	Die eileer westel	Hg	Hg	BL	NIA	Dana	No commont	
12	Pin-silver metal	Cr ⁶⁺	Cr	BL	NA	Pass	No comment	
		PBBs PBDEs	Br	NA				
		Pb	Pb	BL				
		Cd	Cd	BL				
40	OMD trials	Hg	Hg	BL	NIA	D	No. a a susua a su t	
13	SMD triode	Cr ⁶⁺	Cr	BL	NA	Pass	No comment	
		PBBs		r.				
		PBDEs	Br	BL				
		Pb	Pb	BL				
		Cd	Cd	BL				
14	Dark grey solid	Hg	Hg	BL	NA	Pass	No comment	
14	Dark grey solid	Cr ⁶⁺	Cr	BL	INA	Pa55	No comment	
		PBBs	Br	BL				
		PBDEs	ы	DL				
		Pb	Pb	BL				
		Cd	Cd	BL				
15	Copper	Hg	Hg	BL	NA	Pass	No comment	
15	enameled wire	Cr ⁶⁺	Cr	BL	INA		No comment	
		PBBs	Br	BL				
		PBDEs	DI	DL				





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No.	Sample description	Restricted substances	Analytical element	Results of EDXRF ⁽¹⁾	Results of Chemical Testing ⁽²⁾ (mg/kg)	Conclusion	Remark
		Pb	Pb	OL			
		Cd	Cd	BL			0 1 (0)
16	SMD diode	Hg	Hg	BL	Pb:34091	Pass	
10	SIVID diode	Cr ⁶⁺	Cr	BL	FD.34091	F a 5 5	See remark (3)
		PBBs	Br	BL			
		PBDEs	ы	DL			
		Pb	Pb	BL			
	Black hard plastic	Cd	Cd	BL			No comment
17		Hg	Hg	BL	NA	Pass	
''		Cr ⁶⁺	Cr	BL	INA		
		PBBs	Br	BL			
		PBDEs	ы	DL			
		Pb	Pb	BL			
		Cd	Cd	BL	NA		
18	Brown hard	Hg	Hg	BL	IVA	Pass	No comment
10	plastic	Cr ⁶⁺	Cr	BL		1 400	NO COMMENT
		PBBs	Br	Х	ND		
		PBDEs	ы	^	ND		
		Pb	Pb	BL			
		Cd	Cd	BL			
19	Silver metal with	Hg	Hg	BL	NA	Pass	No comment
19	gold plating	Cr ⁶⁺	Cr	BL	INA	F 033	NO COMMENT
		PBBs	Br	NA			
		PBDEs	ום	INA			
		Pb	Pb	BL			
		Cd	Cd	BL			
20	SMD resister	Hg	Hg	BL	NA	n	No comment
20	SIMID IESISIEI	Cr ⁶⁺	Cr	BL	INA	Pass	NO COMMENT
		PBBs	Br	BL			
		PBDEs	DI	DL			





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No.	Sample description	Restricted substances	Analytical element	Results of EDXRF ⁽¹⁾	Results of Chemical Testing ⁽²⁾ (mg/kg)	Conclusion	Remark	
		Pb	Pb	BL				
		Cd	Cd	BL			No comment	
21	Silver metal with	Hg	Hg	BL	NA	Pass		
21	grey plating	Cr ⁶⁺	Cr	BL	IVA	rass	NO Comment	
		PBBs	Br	NA				
		PBDEs	Б	INA				
		Pb	Pb	BL			No comment	
		Cd	Cd	BL		Pass		
22	Dork groon BCB	Hg	Hg	BL	NA			
22	Dark green PCB	Cr ⁶⁺	Cr	BL	INA			
		PBBs	Br	BL				
		PBDEs	ы					
		Pb	Pb	BL			No comment	
		Cd	Cd	BL		Pass		
23	Grey glue	Hg	Hg	BL	NA			
23	Grey gide	Cr ⁶⁺	Cr	BL	IVA	rass	NO Comment	
		PBBs	Br	BL				
		PBDEs	DI	DL				
		Pb	Pb	BL				
		Cd	Cd	BL				
24	Transparent	Hg	Hg	BL	NA	Door	No comment	
24	glass	Cr ⁶⁺	Cr	BL	INA	Pass	No comment	
		PBBs	D.	BL				
		PBDEs	Br	DL				





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Test Results:

2. Phthalates (DBP, BBP, DEHP, DIBP) Test Results:

Test Item	Te	est Result (mg/k	MDL (mg/kg)	Requirement	
Test item	1+2+3	4+7+8	9+10+11	WIDE (Hig/kg)	Limit (mg/kg)
Dibutyl phthalate(DBP)	ND	ND	ND	30	1000
Benzylbutyl phthalate(BBP)	ND	ND	ND	30	1000
Di-2-ethylhexyl phthalate(DEHP)	ND	ND	ND	30	1000
Diisobutyl phthalate(DIBP)	ND	ND	ND	30	1000
Conclusion	Pass	Pass	Pass		

Test Item	To	est Result (mg/k	MDL (mg/kg)	Requirement	
rest item	13+14+15	16+17+18	20+22	MDE (mg/kg)	Limit (mg/kg)
Dibutyl phthalate(DBP)	ND	ND	ND	30	1000
Benzylbutyl phthalate(BBP)	ND	ND	ND	30	1000
Di-2-ethylhexyl phthalate(DEHP)	ND	ND	ND	30	1000
Diisobutyl phthalate(DIBP)	ND	ND ND		30	1000
Conclusion	Pass	Pass	Pass		

Test Item	Test Result (mg/kg) 23+24	MDL (mg/kg)	Requirement Limit (mg/kg)
Dibutyl phthalate(DBP)	ND	30	1000
Benzylbutyl phthalate(BBP)	ND	30	1000
Di-2-ethylhexyl phthalate(DEHP)	ND	30	1000
Diisobutyl phthalate(DIBP)	ND	30	1000
Conclusion	Pass		

Note: mg/kg = parts per million = ppm ND = Not Detected (less than MDL) MDL = Method Detection Limit





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Test Materials List:

Item No.	Description
1	Brown PCB
2	SMD IC
3	SMD IC
4	Dark grey solid
7	SMD IC
8	SMD IC
9	SMD capacitor
10	Black solid
11	SMD IC
13	SMD triode
14	Dark grey solid
15	Copper enameled wire
16	SMD diode
17	Black hard plastic
18	Brown hard plastic
20	SMD resister
22	Dark green PCB
23	Grey glue
24	Transparent glass

Note: As specified by the client, the samples were subjected to mixed testing.





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- Remark: (1) ① Results are obtained by XRF for primary screening, and further wet chemical testing by ICP-OES / AAS (for Cd, Pb, Hg), UV-VIS (for Cr(VI)) and GC-MS (for PBBs, PBDEs) is recommended to be performed, if an inconclusive result was found (as "X" in below table) (unit: mg/kg).
 - ② OL = Over Limit, BL = Below Limit, X = Inconclusive, NA= Not Applicable.
 - ③ XRF screening test for RoHS elements The test result may be different from the actual content in the non-uniformity composition sample.

Element	Polymer	Metal	Composite Materials
Cd	$BL \leq (70-3 \sigma) < X < (130+3 \sigma)$ $\leq OL$	$BL \leq (70\text{-}3\sigma) < X < (130\text{+}3\sigma) \\ \leq OL$	LOD < X <(150+3 σ)≤ OL
Pb	BL ≤(700-3 σ)< X <(1300+3 σ)≤ OL	BL ≤(700-3 σ)< X <(1300+3 σ)≤ OL	BL ≤(500-3 <i>σ</i>)< X <(1500+3 <i>σ</i>)≤ OL
Hg	BL ≤(700-3 <i>σ</i>)< X <(1300+3 <i>σ</i>)≤ OL	BL ≤(700-3 <i>σ</i>)< X <(1300+3 <i>σ</i>)≤ OL	BL ≤(500-3 σ)< X <(1500+3 σ)≤ OL
Br	BL ≤ (300-3 σ)< X	NA	BL ≤ (250-3 σ)< X
Cr	BL ≤ (700-3 <i>σ</i>)< X	BL ≤ (700-3 σ)< X	BL ≤ (500-3 σ)< X

- (2) ① mg/kg = ppm = 0.0001%, ND = Not Detected (less than MDL), MDL = Method Detection Limit.
 - 2 Unit, Method Detection Limit (MDL) and Requirement limit in wet chemical test.

Test items	Pb	Cd	Hg	Cr ⁶⁺ (Non-metal)	Cr ⁶⁺ (metal)	Cr ⁶⁺ (metal) PBBs(single)	
Unit	mg/kg	mg/kg	mg/kg	mg/kg	mg/kg	mg/kg	mg/kg
MDL	2	2	2	8		5	5
Requirement Limit	1000	100	1000	1000	Negative	1000	1000

- 3 According to IEC 62321-7-1:2015, result on Cr⁶⁺ for metal sample shall be shown as Positive/Negative.
 - a) The Cr(VI) concentration is more than 0.13 $\mu g/cm^2$, the sample is positive for Cr(VI), the coating is considered to contain Cr(VI).
 - b) The Cr(VI) concentration is less than 0.10 μg/cm², the sample is negative for Cr(VI), the coating is considered a non-Cr(VI) based coating.

Storage condition and production date of the tested sample are unavailable and thus results of Cr⁶⁺ represent status of the sample at the time of testing.

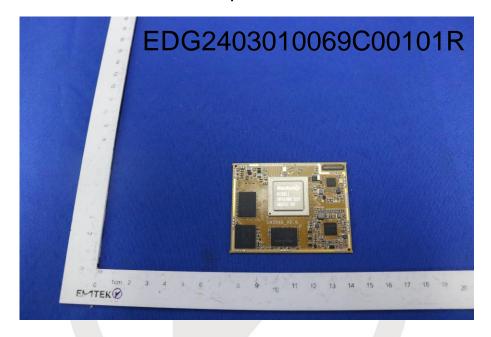
- 4 According to IEC 62321-3-1:2013, this column represents the results of wet chem test. And "NA" means no need to perform wet chem test, when the XRF screening results are acceptable.
- (3) As declared by the client, No.16 the material should be exempted for lead content requirement according to Annex III clause 7(c)-l.





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Sample Photo

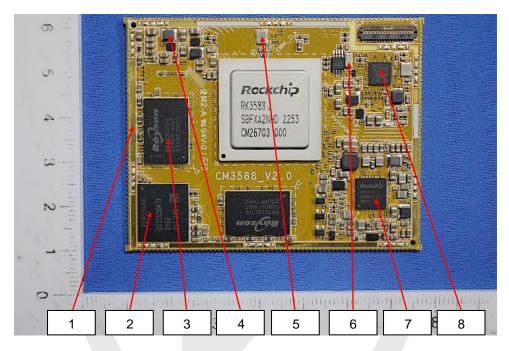


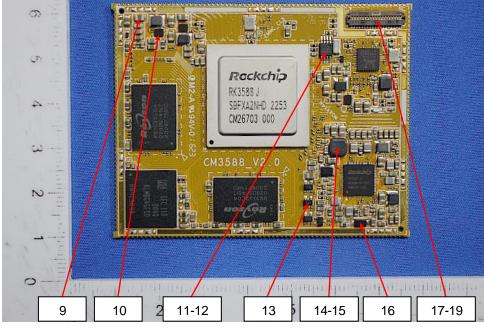




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Sample Photo



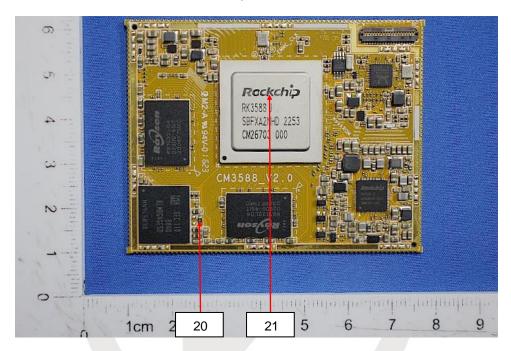


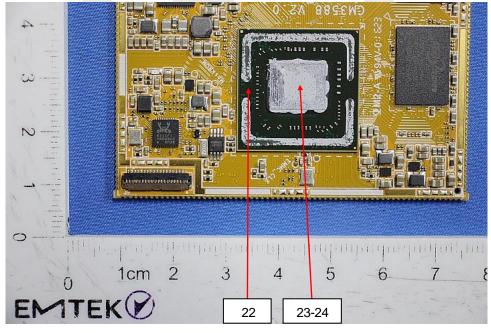




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Sample Photo





End of Report ***





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ANNEX

EXEMPTION LIST

- Mercury in single capped (compact) fluorescent lamps not exceeding (per burner):
- For general lighting purposes < 30W: 5mg (expires on 31 December 2011; 3.5mg may be used per burner after 31 December 2011 until 1(a) 31 December 2012; 2.5mg shall be used per burner after 31 December 2012)
- For general lighting purposes ≥ 30W and <50W: 5mg (expires on 31 December 2011; 3.5mg may be used per burner after 31 1(b)
- For general lighting purposes ≥ 50W and <150W: 5mg 1(c)
- For general lighting purposes ≥ 150W: 15mg 1(d)
- 1(e) For general lighting purposes with circular or square structural shape and tube diameter ≤17mm (no limitation of use until 31 December 2011; 7mg may be used per burner after 31 December 2011)
- 1(f) For special purposes: 5mg
- For general lighting purposes < 30 W with a lifetime equal or above 20 000 h: 3,5 mg (Expires on 31 December 2017) 1(g)
- Mercury in double-capped linear fluorescent lamps for general lighting purples not exceeding (per lamp): 2(a)
- Tri-band phosphor with normal lifetime and a tube diameter < 9mm (e.g. T2): 5mg (expires on 31 December 2011; 4mg may be used 2(a)(1) per lamp after 31 December 2011)
- 2(a)(2)Tri-band phosphor with normal lifetime and a tube diameter ≥ 9mm and ≤ 17mm (e.g. T5): 5mg (expires on 31 December 2011; 3mg may be used per lamp after 31 December 2011)
- Tri-band phosphor with normal lifetime and a tube diameter > 17 mm and ≤ 28 mm (e.g. T8): 5 mg (expires on 31 December 2011; 3.5 mg 2(a)(3)may be used per lamp after 31 December 2011)
- Tri-band phosphor with normal lifetime and a tube diameter > 28mm (e.g. T12): 5mg (expires on 31 December 2012; 3.5mg may be 2(a)(4)used per lamp after 31 December 2012)
- Tri-band phosphor with long lifetime (≥ 25000h): 8mg (expires on 31 December 2011; 5mg may be used per lamp after 31 December 2(a)(5)
- Mercury in other fluorescent lamps not exceeding (per lamp): 2(b)
- 2(b)(2) Non-linear halophosphate lamps (all diameters): 15mg (expires on 13 April 2016)
- 2(b)(3)Non-linear tri-band phosphor lamps with tube diameter > 17mm (e.g. T9) (no limitation of use until 31 December 2011; 15mg may be used per lamp after 31 December 2011)
- 2(b)(4)Lamps for other general lighting and special purposes (e.g. induction lamps) (no limitation of use until 31 December 2011; 15mg may be used per lamp after 31 December 2011)
- Mercury in cold cathode fluorescent lamps and external electrode fluorescent lamps (CCFL and EEFL) for special purposes not exceeding (per lamp):
- Short length (≤ 500mm) (No limitation of use until 31 December 2011; 3.5mg may be used per lamp after 31 December 2011) 3(a)
- Medium length (> 500 m and ≤ 1500 mm) (No limitation of use until 31 December 2011; 5 mg may be used per lamp after 31 December 3(b)
- Long length (> 1500mm) (No limitation of use until 31 December 2011; 13mg may be used per lamp after 31 December 2011) 3(c)
- Mercury in other low pressure discharge lamps (per lamp) (no limitation of use until 31 December 2011; 15mg may be used per lamp 4(a) after 31 December 2011)
- 4(b) Mercury in High Pressure Sodium (vapour) lamps for general lighting purposes not exceeding (per burner) in lamps with improved colour rendering index Ra > 60:
- P ≤ 155W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011) 4(b)-I
- 155W < P ≤ 405W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011) 4(b)-II
- 4(b)-III P > 405W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011)
- Mercury in other High Pressure Sodium (vapour) lamps for general lighting purposes not exceeding (per burner): 4(c)
- 4(c)-I P≤ 155W (no limitation of use until 31 December 2011; 25mg may be used per burner after 31 December 2011)
- 155W < P \(405W \) (no limitation of use until 31 December 2011; 30mg may be used per burner after 31 December 2011) 4(c)-II
- P > 405W (no limitation of use until 31 December 2011; 40mg may be used per burner after 31 December 2011) Mercury in High Pressure Mercury (vapour) lamps (HPMV) (expires on 13 April 2015) 4(c)-III
- 4(d)
- Mercury in metal halide lamps (MH) 4(e)
- Mercury in other discharge lamps for special purposes not specifically mentioned in this Annex 4(f)
- 4(g) Mercury in hand crafted luminous discharge tubes used for signs, decorative or architectural and specialist lighting and light-artwork, where the mercury content shall be limited as follows: (Expires on 31 December 2018)
 - 20 mg per electrode pair + 0,3 mg per tube length in cm, but not more than 80 mg, for outdoor applications and indoor applications exposed to temperatures below 20 °C;
 - 15 mg per electrode pair + 0,24 mg per tube length in cm, but not more than 80 mg, for all other indoor applications.





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ANNEX

EXEMPTION LIST

Continued

5(a))	Lead	in g	lass	of (catl	hod	e ray	tubes	3

- Lead in glass of fluorescent tubes not exceeding 0.2% by w eight 5(b)
- 6(a) Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0.35% lead by weight
- 6(b) Lead as an alloying element in aluminium containing up to 0.4% lead by weight
- 6(c) Copper alloy containing up to 4% lead by weight.
- Lead in high melting temperature type solders (i.e. lead based alloys containing 85% by weight or more lead) 7(a)
- Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission, 7(b)and network management for telecommunications
- 7(c)-l Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound
- Lead in dielectric ceramic in capacitors for a rated voltage of 125V AC or 250V DC or higher 7(c)-II
- 7(c)-III Lead in dielectric ceramic in capacitors for a rated voltage of less than 125V AC or 250V DC (expires on 1 January 2013 and after that date may be used in spare parts for EEE placed on the market before 1 January 2013).
- 7(c)-IV Lead in PZT based dielectric ceramic materials for capacitors being part of integrated circuits or discrete semiconductors
- 8(a) Cadmium and its compounds in one shot pellet type thermal cut-offs (expires on 1 January 2012 and after that date may be used in spare parts for EEE placed on the market before 1 January 2012)
- Cadmium and its compounds in electrical contacts 8(b)
 - Applies to categories 8, 9 and 11 and expires on:
 - 21 July 2021 for categories 8 and 9 other than in vitro diagnostic medical devices and industrial monitoring and control instruments;
 - 21 July 2023 for category 8 in vitro diagnostic medical devices;
 - 21 July 2024 for category 9 industrial monitoring and control instruments, and for category 11
- Cadmium and its compounds in electrical contacts used in: 8(b)-I
 - Applies to categories 1 to 7 and 10 and expires on 21 July 2021.
 - circuit breakers,
 - thermal sensing controls,
 - thermal motor protectors (excluding hermetic thermal motor protectors),
 - ACsw itches rated at:—6 A and more at 250 V AC and more, or
 - 12 A and more at 125 V AC and more,
 - DC sw itches rated at 20 A and more at 18 V DC and more, and
 - sw itches for use at voltage supply frequency ≥ 200 Hz.
- Hexavalent chromium as an anti-corrosion agent of the carbon steel cooling system in absorption refrigerators up to 0.75% by weight in 9 the cooling solution
- Lead in bearing shells and bushes for refrigerant-containing compressors for heating, ventilation, air conditioning and refrigeration 9(b) (HVACR) applications
- Lead used in other than C-press compliant pin connector systems (expires on 1 January 2013 and after that date may be used in spare 11(b) parts for EEE placed on the market before 1 January 2013)
- 13(a) Lead in white glasses used for optical applications
- Cadmium and lead in filter glasses and glasses used for reflectance standards 13(b)
- Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a 14 lead content of more than 80% and less than 85% by weight (expires on 1 January 2011 and after that date may be used in spare parts for EEE placed on the market before 1 January 2011)
- Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip 15
- 17 Lead halide as radiant agent in High Intensity Discharge (HID) lamps used for professional reprography applications
- Lead as activator in the fluorescent powder (1% lead by weight or less) of discharge lamps when used as sun tanning lamps containing 18(b) phosphors such as BSP (BaSi₂O₅:Pb)
- Lead and cadmium in printing inks for the application of enamels on glasses, such as borosilicate and soda lime glass
- Lead in solders for the soldering to machined through hole discoidal and planar array ceramic multilayer capacitors
- 25 Lead oxide in surface conduction electron emitter displays (SED) used in structural elements, notably in the seal frit and frit ring
- 29 Lead bound in crystal glass as defined in Annex 1 (Categories 1, 2, 3 and 4) of Council Directive 69/493/EEC
- Cadmium alloys as electrical/mechanical solder joints to electrical conductors located directly on the voice coil in transducers used in high-pow ered loudspeakers with sound pressure levels of 100 dB (A) and more





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ANNEX

EXEMPTION LIST

Continued

- 31 Lead in soldering materials in mercury free flat fluorescent lamps (which e.g. are used for liquid crystal displays, design or industrial
- 32 Lead oxide in seal frit used for making window assemblies for Argon and Krypton laser tubes
- 33 Lead in solders for the soldering of thin copper wires of 100 µm diameter and less in power transformers
- 34 Lead in cermet-based trimmer potentiometer elements
- 37 Lead in the plating layer of high voltage diodes on the basis of a zinc borate glass body
- 38 Cadmium and cadmium oxide in thick film pastes used on aluminium bonded beryllium oxide
- Cadmium in colour converting II-VI LEDs (< 10 µg Cd per mm2 of light- emitting area) for use in solid state illumination or display systems (expires on 1 July 2014)
- 41 Lead in solders and termination finishes of electrical and electronic components and finishes of printed circuit boards used in ignition modules and other electrical and electronic engine control systems, which for technical reasons must be mounted directly on or in the crankcase or cylinder of hand-held combustion engines (classes SH:1, SH:2, SH:3 of Directive 97/68/EC of the European Parliament and of the Council (2)) (Expires on 31 December 2018)
- 43 Bis (2-ethylhexyl) phthalate in rubber components in engine systems, designed for use in equipment that is not intended solely for consumer use and provided that no plasticised material comes into contact with human mucous membranes or into prolonged contact with human skin and concentration value of bis(2-ethylhexyl) phthalate does not exceed:
 - 30% by weight of the rubber for
 - gasket coatings;
 - solid-rubber gaskets; or
 - rubber components included in assemblies of at least three components using electrical, mechanical or hydraulic energy to do work, and attached to the engine.
 - 10% by weight of the rubber for rubber-containing components not referred to in point (a).
 - For the purposes of this entry, "prolonged contact with human skin" means continuous contact of more than 10 minutes duration or intermittent contact over a period of 30 minutes, per day.
- Lead in solder of sensors, actuators, and engine control units of combustion engines within the scope of Regulation (EU) 2016/1628 of 44 the European Parliament and of the Council, installed in equipment used at fixed positions while in operation which is designed for professionals, but also used by non-professional users.





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